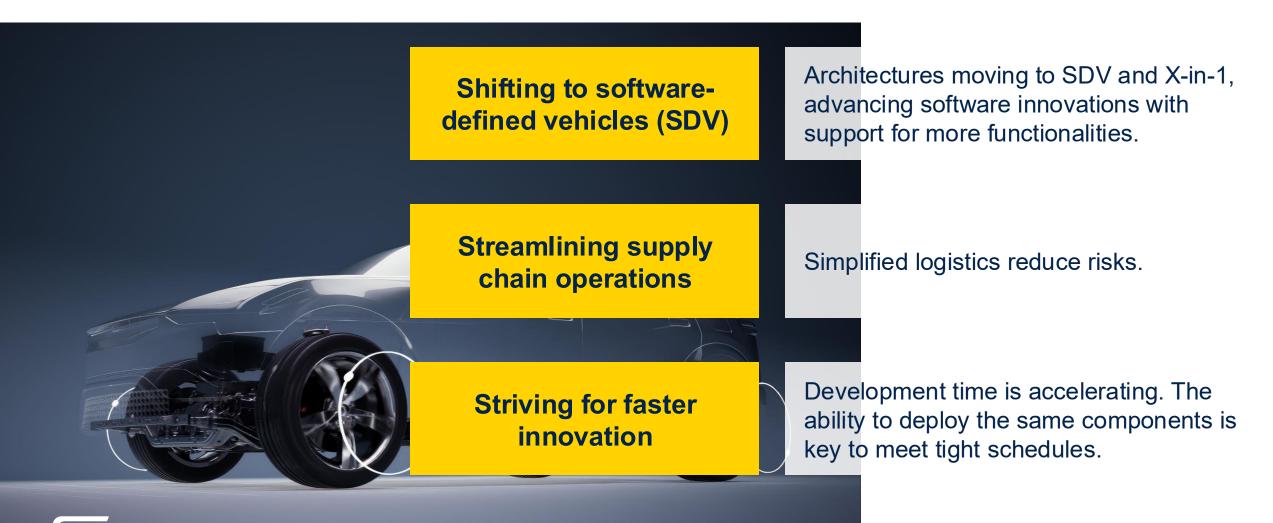


Stellar MCUs with xMemory

Future-proof your designs, accelerate development, and simplify logistics



The trends fostering design scalability









Stellar with xMemory Innovation and smart savings

Innovation unleashed



Headroom for product evolution with zero compromises

Enabling memory-intensive applications

Operational efficiency



Unified procurement
Seamless development
Effortless deployment

Faster time to market



Upgrade through software only in a matter of days

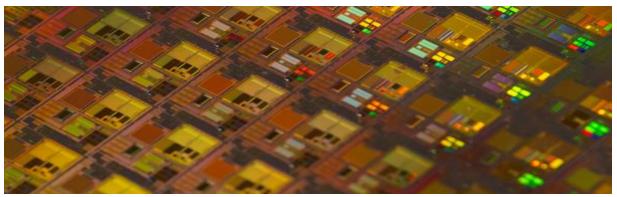
One-code development. Maximizing reuse



Built on ST proprietary, automotive qualified PCM technology, Available on all upcoming Stellar P & G. Production starting later in 2025.

ST phase change memory (PCM) redefines eNVM for automotive MCUs

Proprietary PCM technology: Industry-leading memory density & robustness



Industry smallest embedded NVM cell (28/18 nm)

2X memory density vs. alternatives

0.019 μm² per information bit (28 nm) Best power, performance, area (PPA) index Versus alternative technologies (RRAM, MRAM, Flash)

	Phase Change Memory ***
Memory cell size	Best-in-class
High Temperature	Achieves automotive requirements for AEC-Q100
Radiation immunity	Best-in-class
Technology power efficiency	Lower consumption at more stringent conditions
Production maturity	Mature technology starting SOP vs post eFlash NVMs

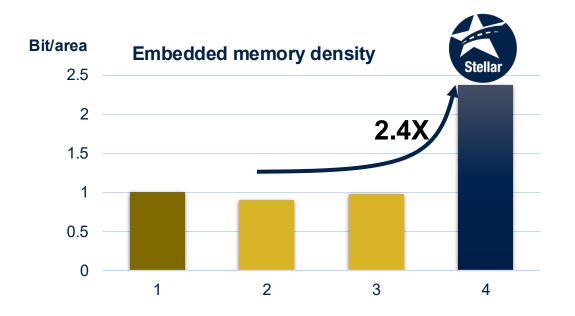
Most dense embedded memory in the market Proven endorsed technology with portability and reliability





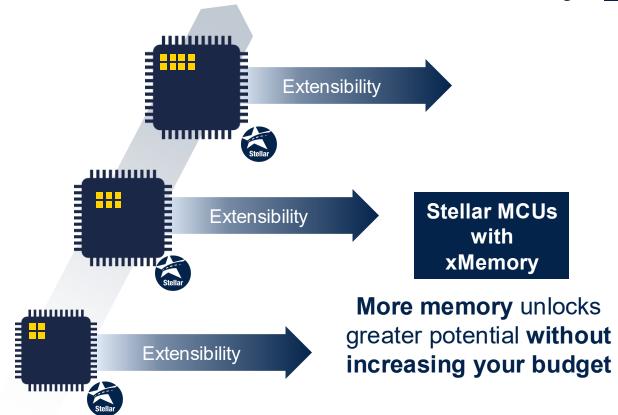
Stellar with xMemory adds a new dimension to scalability

PCM: densest **NVM** qualified for automotive



ST PCM technology delivers >2x the memory density – more than doubling the capacity in the same space

Source: Publicly available industry analysis reports



Stellar with xMemory: one part number with extensible memory supporting multiple or changing project needs



Streamlined procurement

Single part number supporting multiple project memory needs

A **single MCU part number** can support multiple vehicle models with different memory configurations, simplifying customer logistics and reducing costs



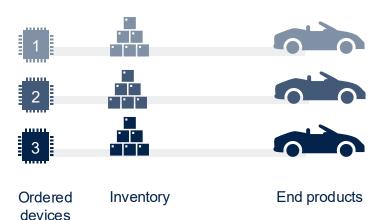
N different MCUs N part numbers N prices

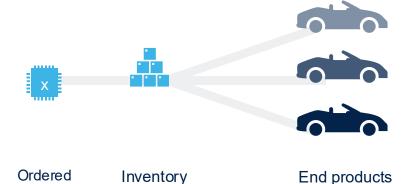




device

One MCU
One part number
One price





Simplified supply chain

Reduced inventories and costs

Flexibility across projects

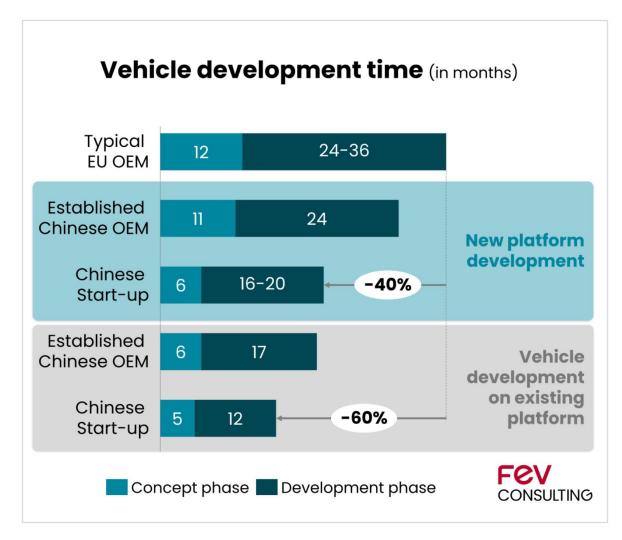
Risk mitigation during shortages

Management of volume fluctuations

EOL management



Time to market: the strategic edge in the OEM race



Vehicle development accelerators

Extensibility

Platforms need to rely on **extensible devices** to be used across all models, reducing development time and effort

Reusability

Modular platforms, virtually **unlimited upgrades** through software



TTM and higher ROI

Future proof

With ability for **upgrades as software complexity increases** and new features are introduced



xMemory on Stellar G and P lines

Stellar for X-in-1 and zonal architectures



Stellar P

arm

Integration platform
High performance actuation

Products ready: P7, P6, P3
Multiple additional in roadmap



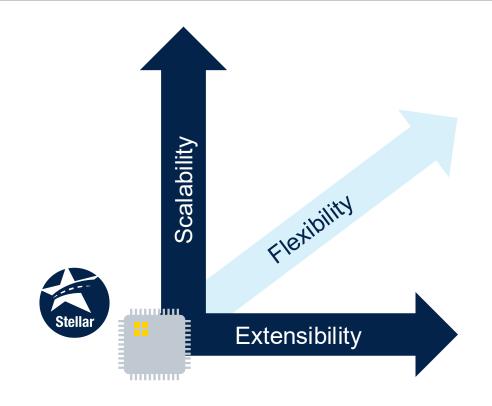
Stellar G

arm

Data and I/O aggregation Ethernet centric, including switch

Products ready: G7
Multiple additional in roadmap

With xMemory, ST now offers a very flexible automotive MCU portfolio with a scalable Stellar family and adding extensibility through proprietary PCM technology.





Our technology starts with You





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